

Title (en)
Polishing process and device for polishing of rotationally symmetric workpieces

Title (de)
Polierverfahren und Vorrichtung zum Polieren rotationssymmetrischer Werkstücke

Title (fr)
Procédé et dispositif de polissage pour des pièces ayant une symétrie de rotation

Publication
EP 1362669 B1 20060906 (DE)

Application
EP 03003748 A 20030219

Priority
DE 10221842 A 20020516

Abstract (en)
[origin: EP1362669A2] The polishing process for the machine polishing of workpieces (F) involves immersing the workpiece in a container (12) filled with grinding material and moving it relative to the grinding material. The workpiece is moved up and down in the vertical direction, rotated about its own central axis (B) and moved with its central axis inside the container.

IPC 8 full level
B24B 31/00 (2006.01)

CPC (source: EP US)
B24B 31/003 (2013.01 - EP US)

Cited by
CN104511825A; CN113561046A; EP2108481A3; KR20150140280A; EP3098026A1; EP2384856A1; WO2014166594A1; US10166651B2; US10357866B2

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